

20V, 17mΩ, 6A, N-Channel Enhancement Mode Power MOSFET

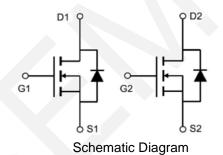
1.Features

- High Power and current handing capability
- Lead free product is acquired
- Surface Mount Package

2.Applications

- Battery protection
- Load Switch
- Power management





Pin Description

3.Absolute Max Ratings at Ta=25°C (Note1)

Parameter		Maximum	Units				
Drain to Source Voltage	V _{DSS}	20	V				
Gate to Source Voltage	V _{GSS}	±12	V				
Drain Current-Continuous	ID	6	А				
Drain Current (Pulse)	Ідм	17	А				
Maximum Power Dissipation	PD	1.5	W				
Operating Junction and Storage Temperature Range	Tj, T _{stg}	-55 to +150	°C				

Note 1: Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

4.Thermal Characteristic

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction to Ambient (Note 2)	Reja	68	°C/W

Note 2: When mounted on 1 inch square copper board t \leq 10sec The value in any given application depends on the user's specific board design.



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Units
Drain to Source Breakdown Voltage	V _{(BR)DSS}	I _D = 250µA, V _{GS} = 0V	20			V
Zero-Gate Voltage Drain Current	IDSS	V _{DS} = 16V, V _{GS} = 0V			1	μA
Gate-Body Leakage Current	I _{GSS}	V_{GS} = ±12V, V_{DS} = 0V			±10	μA
Gate Threshold Voltage	$V_{\text{GS(th)}}$	$V_{DS}=V_{GS}$, $I_{DS}=250\mu A$	0.45	0.9	1.25	V
Drain to Source On-State Resistance	R _{DS(on)}	I _D = 5A, V _{GS} = 2.5V		34		mΩ
		I _D = 5A, V _{GS} = 3V		24		mΩ
		I _D = 6A, V _{GS} = 4.5V		17		mΩ
		I _D = 6A, V _{GS} = 7.4V		16		mΩ
		I _D = 6A, V _{GS} = 10V		15		mΩ
Diode Forward Voltage	V_{SD}	$I_{\rm S}$ = 1A, $V_{\rm GS}$ = 0			1	V
Input Capacitance	Ciss	V _{GS} =0V, V _{DS} =10V, Frequency=1.0MHz		358		pF
Output Capacitance	Coss			69.3		pF
Reverse Transfer Capacitance	C _{rss}			58.5		pF
Turn-ON Delay Time	t _{d(on)}	$V_{DS} = 10V,$ $V_{GS} = 4.5V,$ $R_{GEN} = 3\Omega,$ $I_D = 6A$		16		ns
Turn-ON Rise Time	tr			51		ns
Turn-OFF Delay Time	$t_{d(off)}$			21		ns
Turn-ON Fall Time	t _f			19		ns
Total Gate Charge	Qg	V _{DS} = 10V, V _{GS} = 4.5V,		5.6		nC
Gate-Source Charge	Qgs			0.8		nC
Gate-Drain Charge	Q _{gd}	I _D = 3A		1		nC

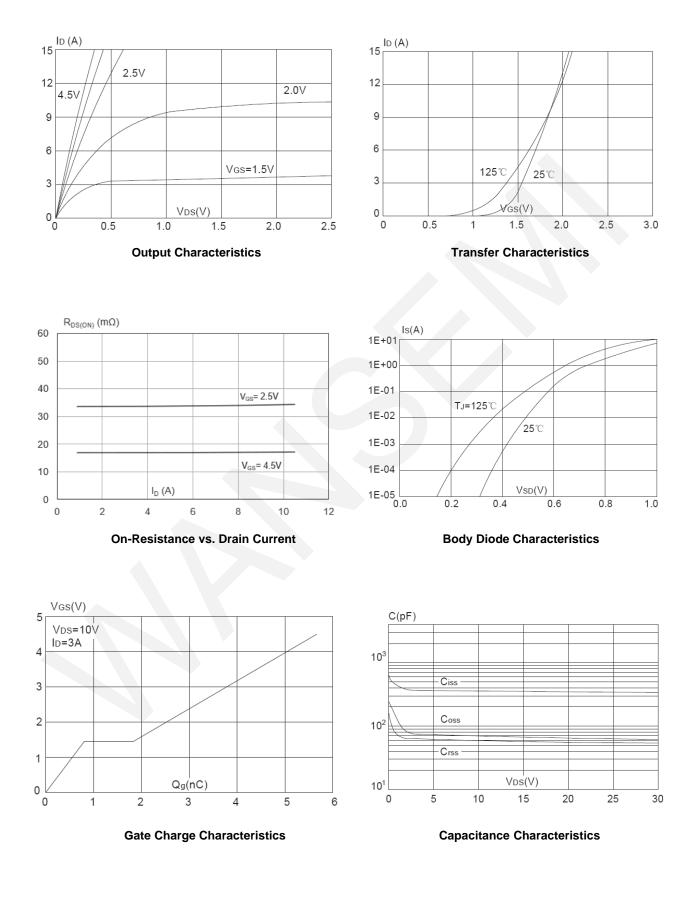
5. Electrical Characteristics at Ta=25°C (Note 3)

Note 3: Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.



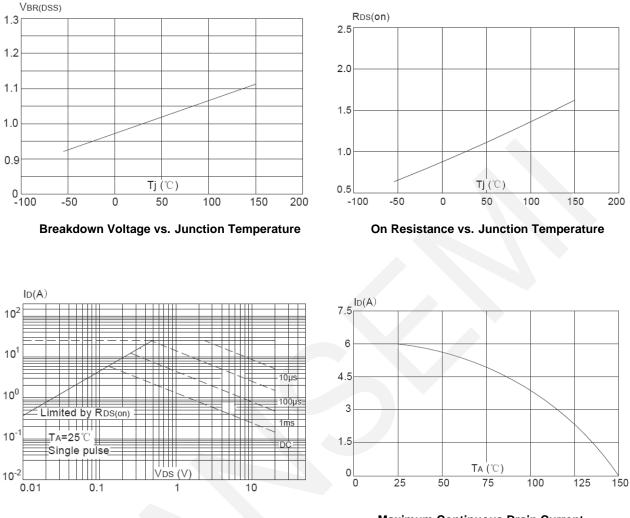


6.Typical electrical and thermal characteristics

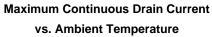


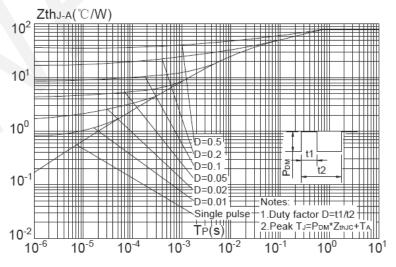






Maximum Safe Operating Area

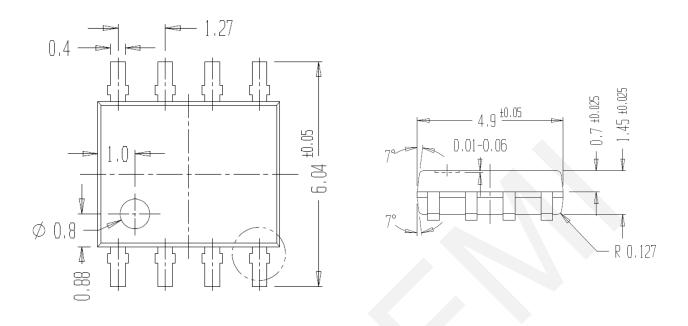


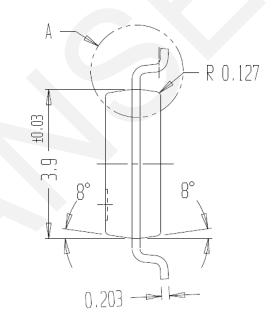


Maximum Effective Transient Thermal Impedance, Junction-to-Ambient



7.Package Dimensions









9.Important Notice

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